

**REPLY UNDER 37 CFR 1.116  
EXPEDITED PROCEDURE  
TECHNOLOGY CENTER 2800**

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

**In Re Application of:** Angyal *et al.*      **Conf. No.:** 4705  
**Serial No.:** 10/710,706      **Art Unit:** 2813  
**Filed:** 07/29/2004      **Docket No.:** FIS920040028US1 (IBMF-0053)  
**Examiner:** Monica D. Harrison

**Title:** INTERLEVEL DIELECTRIC  
LAYER AND METAL LAYER  
SEALING

Mail Stop AF  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

*not entered  
monica D. Harrison  
6/23/06*

**AFTER FINAL REQUEST FOR RECONSIDERATION**

Sir:

**INTRODUCTORY COMMENTS**

In response to the Final Office Action of February 22, 2006, please re-consider the rejections based on the following remarks.